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STW40N95K5

N-channel 950 V, 0.110 Ω typ., 38 A MDmesh[™] K5 Power MOSFET in a TO-247 package

Datasheet - production data

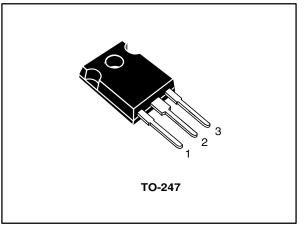
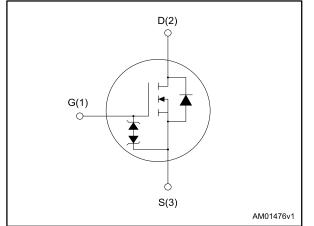


Figure 1: Internal schematic diagram



Features

Order code	VDS	R _{DS(on)} max	ID	Ртот
STW40N95K5	950 V	0.130 Ω	38 A	450 W

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packaging	
STW40N95K5	40N95K5	TO-247	Tube	

DocID026447 Rev 2

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate- source voltage	± 30	V
ID	Drain current (continuous) at T _C = 25 °C	38	А
ID	Drain current (continuous) at T _C = 100 °C	24	Α
IDM ⁽¹⁾	Drain current (pulsed)	152	А
Ртот	P_{TOT} Total dissipation at T _c = 25 °C		W
I _{AR}	Max current during repetitive or single pulse avalanche	13	Α
Eas	E _{AS} Single pulse avalanche energy (starting $T_J = 25 \text{ °C}$, $I_D = 13 \text{ A}$, $V_{DD} = 50 \text{ V}$)		mJ
dv/dt (2)	Peak diode recovery voltage slope	4.5	V/ns
dv/dt ⁽³⁾	v/dt ⁽³⁾ MOSFET dv/dt ruggedness		V/ns
T _j T _{stg}	Operating junction temperature -55 to 150		°C

Notes:

 $^{(1)}Pulse width limited by safe operating area.$ $<math display="inline">^{(2)}I_{SD} \leq$ 19 A, di/dt \leq 100 A/µs, V_{DS(peak)} \leq V(BR)DSS. $^{(3)}V_{DS} \leq$ 760 V

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.28	°C/W
Rthj-amb	R _{thj-amb} Thermal resistance junction-amb max		°C/W



2 **Electrical characteristics**

(T_{case} =25 °C unless otherwise specified)

Table 4: On /off states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V(BR)DSS	Drain-source breakdown voltage	$V_{GS} = 0, I_{D} = 1 \text{ mA}$	950			V
	I _{DSS} Zero gate voltage drain current	$V_{GS} = 0, V_{DS} = 950 V$			1	μA
IDSS		$V_{GS} = 0, V_{DS} = 950 V,$ T _C =125 °C			50	μA
lgss	Gate-body leakage current	$V_{DS}=0, V_{GS}=\pm 20 V$			±10	μA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \ \mu A$	3	4	5	V
$R_{\text{DS(on)}}$	Static drain-source on- resistance	$V_{GS}=10~V,~I_{D}=19~A$		0.110	0.130	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	3300	-	pF
Coss	Output capacitance	V _{GS} =0, V _{DS} =100 V, f=1 MHz	-	250	-	pF
Crss	Reverse transfer capacitance	Vus=0, Vbs=100 V, 1=1 Winz	-	2	-	pF
Co(tr) ⁽¹⁾	Equivalent capacitance time related		-	398	-	pF
$C_{o(er)}^{(2)}$	Equivalent capacitance energy related	$V_{GS} = 0, V_{DS} = 0$ to 760 V	-	142	-	pF
RG	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D=0$	-	5	-	Ω
Qg	Total gate charge	$V_{DD} = 760 \text{ V}, \text{ I}_{D} = 38 \text{ A}$	-	93	-	nC
Q_{gs}	Gate-source charge	V _{GS} =10 V	-	18.7	-	nC
Q _{gd}	Gate-drain charge	(see Figure 16: "Gate charge test circuit")	-	63.4	-	nC

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

 $^{(2)}$ energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% VDSS

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 475 V, I _D = 19 A,	-	33.5	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 15: "Switching times test circuit for resistive load")	-	51	-	ns
$t_{d(off)}$	Turn-off-delay time		-	91.5	-	ns
tr	Fall time		-	10	-	ns

Table 6: Switching times



Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
Isd	Source-drain current		-		38	А
Isdm ⁽¹⁾	Source-drain current (pulsed)		-		152	А
V _{SD} ⁽²⁾	Forward on voltage	$I_{\text{SD}}=38\text{ A},V_{\text{GS}}=0$	-		1.5	V
trr	Reverse recovery time	I _{SD} = 38 A, di/dt = 100 A/μs	-	706		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 18: " Unclamped inductive load test circuit")	-	22		μC
IRRM	Reverse recovery current		-	62		А
trr	Reverse recovery time	I _{SD} = 38 A, di/dt = 100 A/μs	-	886		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V T _J = 150 °C (see Figure 18: " Unclamped inductive load test circuit")	-	28.2		μC
Irrm	Reverse recovery current		-	64		А

Table 7: Source drain diode

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{(2)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

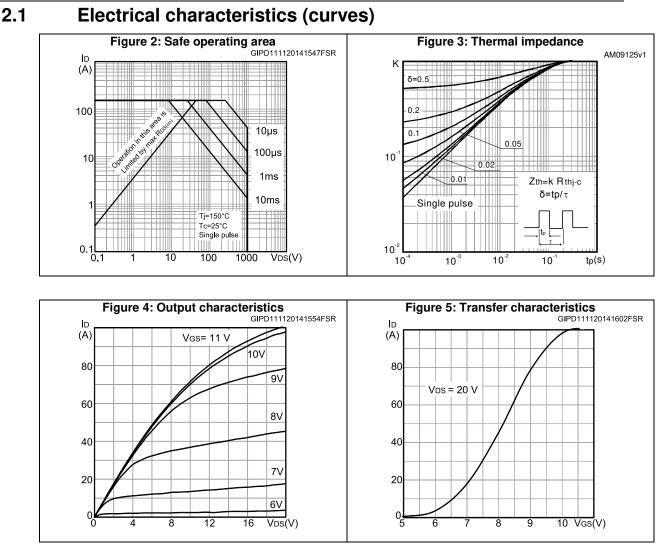
Table 8: Gate-source Zener diode

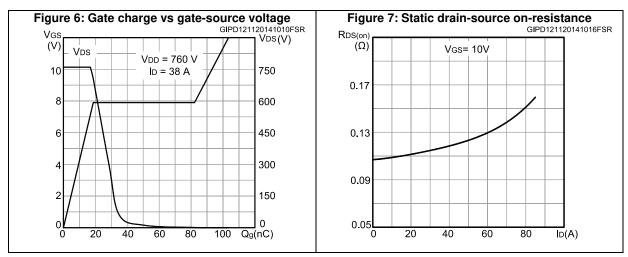
Symbol	Parameter	Test conditions	Min	Тур.	Max.	Unit
V _(BR) GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{mA}, I_{D}=0$	30	-	-	V

The built-in back-to-back Zener diodes have specifically been designed to enhance the device's ESD capability. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.



Electrical characteristics

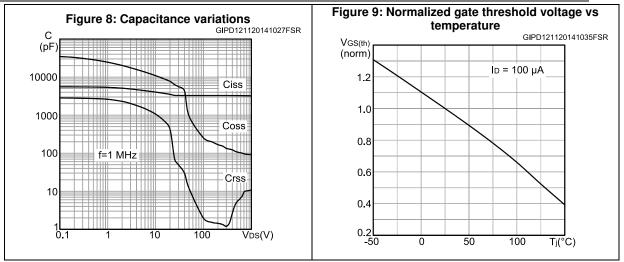


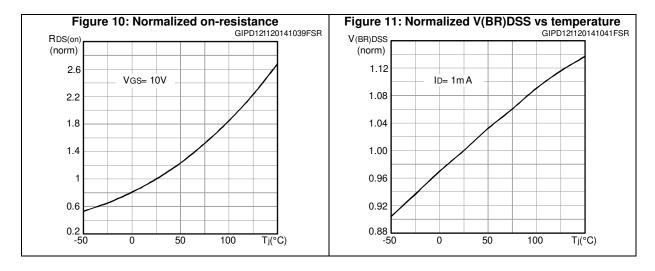


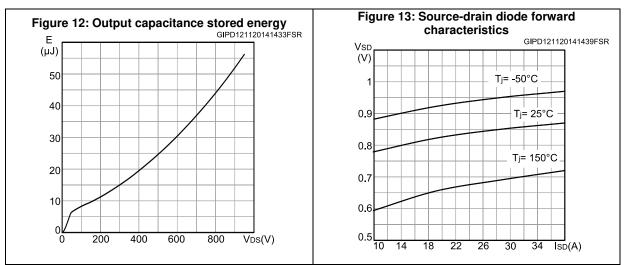


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Electrical characteristics



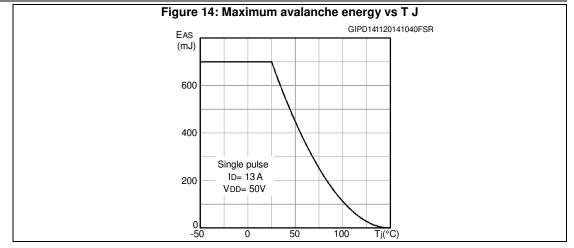




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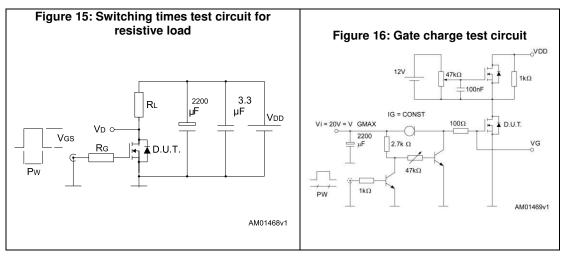
Electrical characteristics

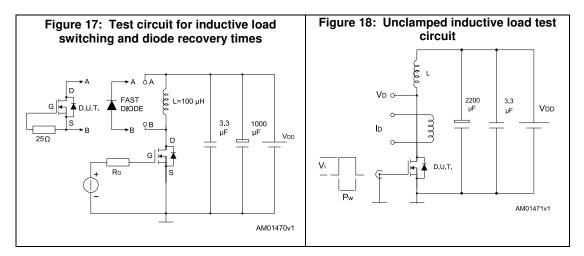
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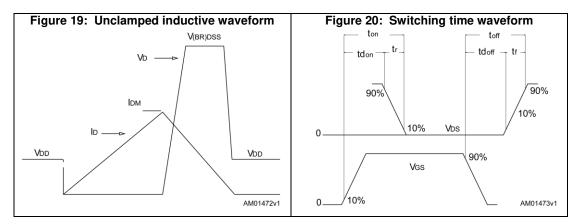


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3 Test circuits



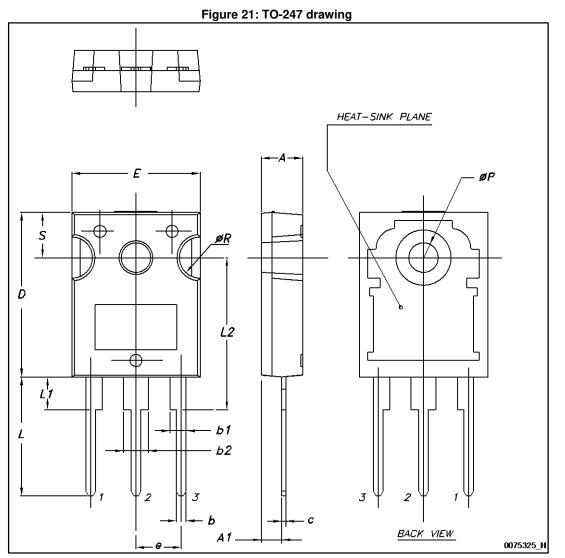




4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information





STW40N95K5

Package mechanical data

	Table 9: TO-247 mechanical data					
Dim		mm.				
Dim.	Min.	Тур.	Max.			
A	4.85		5.15			
A1	2.20		2.60			
b	1.0		1.40			
b1	2.0		2.40			
b2	3.0		3.40			
С	0.40		0.80			
D	19.85		20.15			
E	15.45		15.75			
е	5.30	5.45	5.60			
L	14.20		14.80			
L1	3.70		4.30			
L2		18.50				
ØP	3.55		3.65			
ØR	4.50		5.50			
S	5.30	5.50	5.70			



Revision history 5

Table 10: Document revision history

Date	Revision	Changes
03-Jun-2014	1	First release.
14-Nov-2014	2	Document status promoted from preliminary to production data. Added <i>Section 2.1: "Electrical characteristics (curves)"</i> .



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